#### Ceramic

## **Bandpass Filter**

BFHK-2582+

50Ω 24.25 to 27.50 GHz

#### **The Big Deal**

- 5G n258 bandpass filter
- Low Insertion Loss Mid band 2.0dB typical
- Pick and place standard case style
- Small size 4.5mm x 3.2mm
- High quality distributed filter topology



#### **Product Overview**

The BFHK-2582+ LTCC Bandpass Filter covers the 5G n258 band. This corresponds to a passband of 24.25 to 27.5 GHz, with as low as 2dB passband loss, and up to 58dB stopband rejection. This model handles up to 1W RF input power and provides a wide operating temperature range from -55 to +125°C. Utilizing a proprietary LTCC material system and a distributed filter topology, this filter is able to achieve repeatable performance on a lot to lot basis, up to mmWave frequencies.

#### **Key Features**

Feature	Advantages
5G n258 band	Designed for 5G Telecommunications, n258 band, 24.25 - 27.50 GHz
Proprietary mmWave compatible LTCC material system	Low loss and repeatable performance on a lot to lot basis up to mmWave frequencies.
Cost effective	LTCC is scalable technology that is cost effective due to ease of production in high quantities.
Small size (4.5mm x 3.2mm)	Allows for high layout density of circuit boards, while minimizing effects of parasitics.

#### Ceramic

## **Bandpass Filter**

24.25 to 27.50 GHz  $50\Omega$ 

#### **Features**

#### **Applications**

- Small size
- Temperature stable
- · Hermetically sealed
- LTCC construction

• 5G Telecommunications

## **BFHK-2582+**



Generic photo used for illustration purposes only

CASE STYLE: NM1812C-2

+RoHS Compliant
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications



#### **Maximum Ratings**

Operating Temperature	-55°C to +125°C
Storage Temperature	-55°C to +125°C
RF Power Input	1W at 25°C

Permanent damage may occur if any of these limits are exceeded.





#### Electrical Specifications<sup>1</sup> at 25°C

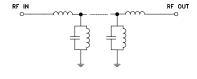
Para	meter	F#	Frequency (GHz)	Min.	Тур.	Max.	Unit
	Center Frequency	_			25.8		MHz
			24.25 - 24.56	_	4	_	
Pass Band	Insertion Loss	F1-F2	24.56 - 26.45	_	2	4.5	dB
			26.45 - 27.5	_	4	_	
	Return Loss	F1-F2	24.25 - 27.5	_	10	_	dB
			DC - 9	45	58	_	
Stop Band, Lower	Insertion Loss	DC-F3	9 - 21	34	40	_	dB
			21 - 21.7	_	40	_	
			29.43 - 33	_	30	_	
Stop Band, Upper	Insertion Loss	F4-F5	33 - 35.4	21	30	_	dB
			35.4 - 46	_	25	_	

<sup>1.</sup> Measured on Mini-Circuits Characterization Test Board TB-BFHK-2582C+ with feedline losses removed by normalization of S12 and S21 traces to measurement of TB thru-line.

#### **Pad Connections**

Input	1
Output	2
Ground	3

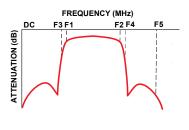
#### **Functional Schematic**

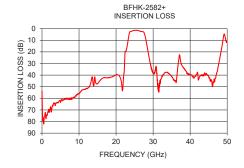


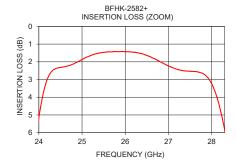
#### Typical Performance Data at 25°C

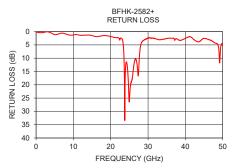
Frequency (GHz)	Insertion Loss (dB)	Return Loss (dB)
1	76.49	0.38
5	63.57	1.12
10	56.27	1.26
15	47.15	1.51
20	39.84	1.86
23	14.86	2.70
24	2.32	12.94
25	1.46	26.07
26	1.64	14.78
27	2.54	11.86
28	8.70	5.33
30	38.18	2.42
35	40.95	2.58
40	39.07	2.56
45	41.01	2.57
50	10.66	4.74

#### **Specification Definition**

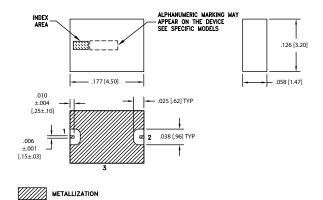








#### **Outline Drawing**



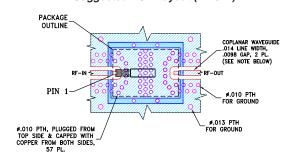
Weight: .064 grams. Dimensions are in inches [mm]

**Product Marking: F415** 

#### **Pad Connections**

Input	1
Output	2
Ground	3

#### Demo Board MCL P/N: TB-BFHK-2582C+ Suggested PCB Layout (PL-677)



- NOLES:

  1. TRACE WIDTH AND GAP ARE SHOWN FOR MEGTRON? WITH DIELECTRIC THICKNESS: .0079±.001";

  COPPER: HVIP/HVIP.

  FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.

  2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER). DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

#### **Additional Notes**

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp



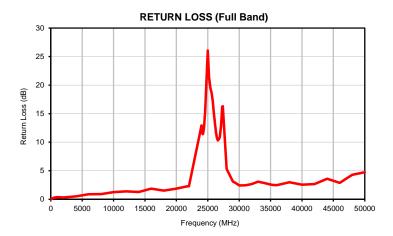
FREQUENCY	INSERTION LOSS	RETURN LOSS
(MHz)	(dB)	(dB)
10 500	53.79 82.01	0.01 0.29
1000	76.49	0.38
2000	72.06	0.33
4000	63.57	0.50
6000 8000	60.71 60.85	0.88 0.90
10000	56.27	1.26
12000	51.65	1.39
14000	49.14	1.29
16000 18000	43.63 41.98	1.87 1.52
20000	39.84	1.86
21700	53.55	2.26
22000	42.83	2.30
24000	2.32	12.94
24100 24200	2.28 2.21	11.68 11.39
24250	2.17	11.47
24300	2.12	11.80
24350	2.06	12.10
24400 24450	2.00 1.94	12.53 13.23
24450 24500	1.94	13.23
24550	1.81	14.78
24560	1.79	14.97
25000	1.46	26.07
25200 25400	1.43 1.42	21.47 19.49
25600	1.44	18.64
25800	1.49	17.15
26000	1.64	14.78
26050 26100	1.68 1.74	14.32 13.64
26150	1.80	13.04
26200	1.85	12.67
26250	1.92	12.16
26300	1.98	11.66
26350 26400	2.05 2.11	11.47 11.08
26450	2.18	10.73
26500	2.23	10.68
26600	2.34	10.30
26700 26800	2.42 2.48	10.43 10.58
26900	2.46 2.52	10.88
27000	2.54	11.86
27100	2.55	12.82
27200 27300	2.57 2.66	14.40 16.25
27300 27400	2.87	16.25 16.29
27500	3.24	14.47
28000	8.70	5.33
29000	26.16	3.12
29430 30000	32.68 38.18	2.86 2.42
31000	38.68	2.46
32000	44.43	2.67
33000	38.27	3.08
34000	38.11	2.86
35000	40.95	2.58
35400	43.16	2.51
36000	44.59	2.49
38000	32.82	2.99 2.56
40000 42000	39.07 37.50	2.56 2.67
44000	38.74	3.60
46000	49.95	2.87
48000	25.72	4.29
50000	10.66	4.74

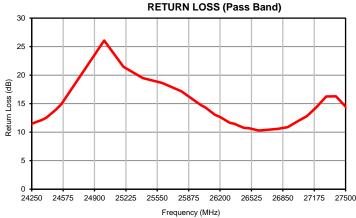










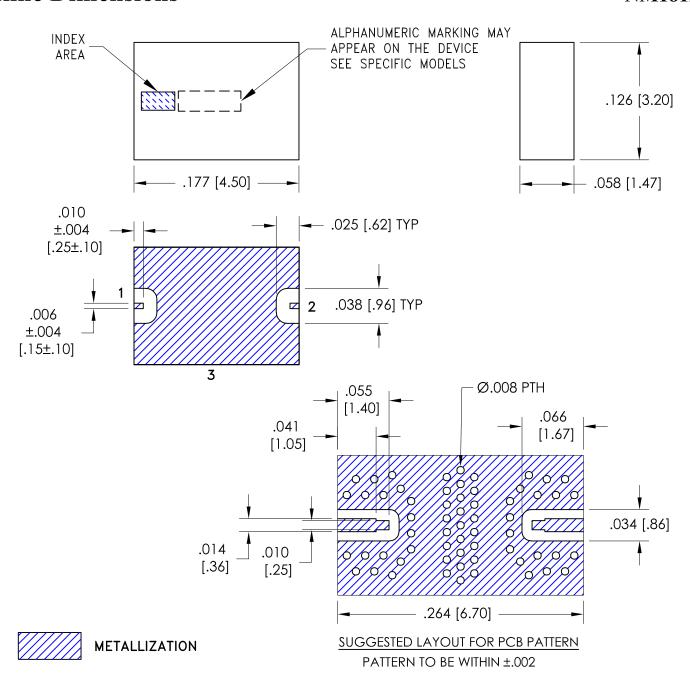


## Case Style

### NM

#### **Outline Dimensions**

NM1812C-2



Weight: .064 grams.

Dimensions are in inches (mm). Tolerances: 2 Pl.±.01; 3 Pl. ±.005

#### Notes:

- 1. Case material: Ceramic.
- 2. Termination Finish: **as shown below or indicated on Data Sheet.**For RoHS Case Styles: Tin Plate over Nickel plate. All models, (+) suffix.





P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



## Tape & Reel Packaging TR-F77

## DEVICE ORIENTATION IN T&R INDEX DEVICE CAVITY PITCH TAPE WIDTH

INDEX -

Note: The location and shape of the metallization may differ

Note: The shape of the pocket may differ

Applicable Case Styles

DIRECTION OF FEED

GU1604, GU1804, GU2644, TT1618-2 TAPE WIDTH

**DEVICE ORIENTATION IN T&R** 

DEVICE CAVITY

Applicable Case Styles

DIRECTION OF FEED

MZ4532C, NM1812C, NM1812C-1, NM1812C-2, NM1812C-3, NM1812C-5, NM1812C-6, NM3237

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices pe	er Reel
12	8	7	Small quantity standards (see note)	20 50 100 200 500 1000
		13	Standard	2000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

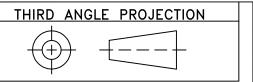


INTERNET http://www.minicircuits.com

P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661

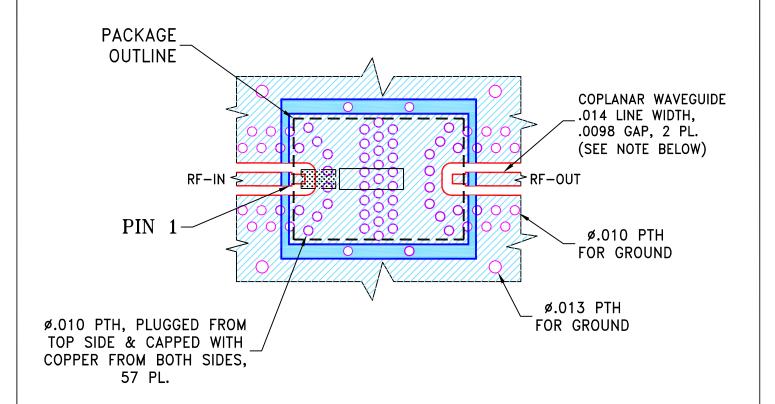
Distribution Centers NORTH AMERICA 800-654-7949 • 417-335-5935 • Fax 417-335-5945 • EUROPE 44-1252-832600 • Fax 44-1252-837010

Mini-Circuits ISO 9001 & ISO 14001 Certified



		REVISIONS			
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	ECO-003081	NEW RELEASE	06/24/20	ITG	WY
A	ECO-003526	UPDATED PATTERN	08/03/20	GF	WY

## SUGGESTED MOUNTING CONFIGURATION FOR NM1812C-2 CASE STYLE



#### **NOTES:**

- 1. TRACE WIDTH AND GAP ARE SHOWN FOR MEGTRON7 WITH DIELECTRIC THICKNESS: .0079±.001"; COPPER: HVLP/HVLP.
  FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
- 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



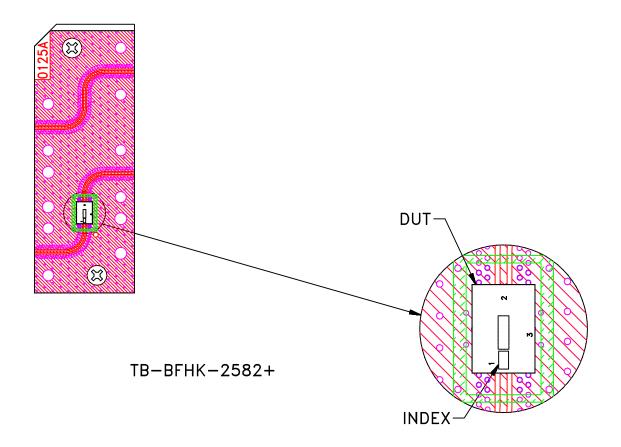
DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).

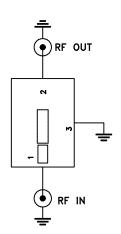


DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

UNLESS OTHERWISE SPECIFIE	D	INITIALS	DATE	J ┌─			•	• 4 ®			
DIMENSIONS ARE IN INCHES	DRAWN	ITG	06/24/20		Mini	ı — C	ircu	its :	3 Neptu	ne Ave	nue
TOLERANCES ON: 2 PL DECIMALS ±	CHECKED	GF	06/24/20					В	rookiyn	NI II	ຂວວ
3 PL DECIMALS ± .005	APPROVED	WY	06/24/20	1							
FRACTIONS ±				1	PL, NI	M181	2C-2.	TB-1	135	+	
□ Min	i–Circuits ®						,				
THIS DOCUMENT AND ITS CONTENTS EXCEPT FOR USE EXPRESSLY GRANT AND THE UNITED STATES GOVERNME	ED, IN WRITING, T	O ITS VENDORS, V	ENDEE	SIZE	CODE IDENT	DRAWING	NO:			REV:	
DESIGN, USE , MANUFACTURING AND THESE CONTENTS SHALL NOT BE US	REPRODUCTION R ED, DUPLICATED O	IGHTS THERETO. OR DISCLOSED TO A	ANY OUTSIDE	A	15542		98-PL	-677			A
PARTY, IN WHOLE OR IN PART, WITH	IOUT WRITTEN PER	MISSION OF MINI-	CIRCUITS.	FILE:	98PL677	SCALE:	10.1	SHEET:	1	ΛF	1
	ASHEETA1.D	WG REV:A DA	ATE:01/12/95		AOLTO!!		10:1		1	Ur	T

### Evaluation Board and Circuit





Schematic Diagram

- 1. 50 Ohm 1.85 mm Female end launch connectors.
- 2. PCB Material: Megtron 7 R5785(N) or equivalent, Dielectric Constant=3.6 Thickness=.008 inch.

Mini-Circuits®

# Mini-Circuits

## **Environmental Specifications**

ENV06T8

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Thermal Cycling	-55 to 125°C, 100 cycles, Dwell Time 15 minutes.	MIL-STD-202, Method 107, Condition A-3
Mechanical Shock	50g, 11ms half-sine, 18 shocks applied each to 3 axes	MIL-STD-202 Method 213, Condition A
Vibration	10-2000Hz sine, 20g, 12 cycles applied each to 3 axes	MIL-STD-202, Method 204, Condition D
Constant Acceleration	30Kg, Y1 Direction	MIL-STD-883, Method 2001, Condition E
Humidity	85°C, 90-95% Relative Humidity, 250hours	
Solderability	10X / 30X Magnification	J-STD-002C Test S, J-STD-002C Test S1
High Temp Storage	125°C, 250 hours	